

Product Information Sheet EPO-TEK® OH105-2

Date: Rev:	April 2018 VI	
No. of Components: Mix Ratio by Weight:	Two 4 · 1	
Specific Gravity:	Part A: 1.15	Part B: 0.95
Pot Life: Shelf Life- Bulk:		

Recommended Cure: 80°C / 2 Hours

Minimum Alternative Cure(s): May not achieve performance properties listed below 23°C / 24 Hours

NOTES:

• Container(s) should be kept closed when not in use.

• Filled systems should be stirred thoroughly before mixing and prior to use.

• Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packages.

• Syringe packaging will impact initial viscosity and effective pot life, potentially beyond stated parameters.

Product Description: Two component, optically opaque epoxy. It is a more flexible, thixotropic alternative to EPO-TEK® 320.

 Typical Properties:
 Cure condition: 80°C / 2 Hours
 Different batches, conditions & applications yield differing results.

 Data below is not guaranteed.
 To be used as a guide only, not as a specification.
 * denotes test on lot acceptance basis

PHYSICAL	PROPERTIES

PHYSICAL PROPERTIES:				
* Color (before cure):	Part A: Black	Part B: Clear/colorless		
* Consistency: Smooth thixotrop		pic paste		
* Viscosity (23°C) @ 10 rpm:	17,000-26,000	cPs		
Thixotropic Index:	7.2			
* Glass Transition Temp:	≥ 30	°C (Dynamic Cure: 20-200°C/ISO 25 Min; Ramp -10-200°C @20°C/Min)		
Coefficient of Thermal Expansion (CT	E):			
Below	Tg: 54	x 10 ⁻⁶ in/in°C		
Above	Tg: 233	x 10 ⁻⁶ in/in°C		
Shore D Hardness:	60			
Lap Shear @ 23°C:	> 2,000	psi		
Die Shear @ 23°C:	≥ 10	Kg 3,556 psi		
Degradation Temp:	330	°Č		
Weight Loss:				
@ 200	0°C: 0.58	%		
@ 250	0°C: 1.17	%		
@ 300	0°C: 3.45	%		
Suggested Operating Temperature:	< 275	°C (Intermittent)		
Storage Modulus:	350,925	psi		
* Particle Size:	≤ 20	microns		
ELECTRICAL AND THERMAL PROPERTIES:				
Thermal Conductivity:	N/A			
Volume Resistivity @ 23°C:	$\geq 2 \times 10^8$	Ohm-cm		
Dielectric Constant (1KHz):	8.89			
Dissipation Factor (1KHz):	0.057			
	0.001			
OPTICAL PROPERTIES @ 23°C:				
Spectral Transmission:	< 1% @ 300-2500	nm		
Refractive Index:	N/A			

This information is based on data and tests believed to be accurate. Epoxy Technology, Inc. makes no warranties (expressed or implied) as to its accuracy and assumes no liability in connection with any use of this product. EPOXY TECHNOLOGY, INC. 14 FORTUNE DRIVE, BILLERICA, MA 01821 (978) 667-3805, FAX (978) 663-9782 www.epotek.com